

09/649,827

L Number	Hits	Search Text	DB	Time stamp
-	442	thermoset\$5 with thermoplastic with tape	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/25 20:14
-	25	(thermoset\$5 with thermoplastic with tape) same double adj3 side\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/25 20:25
-	120	(thermoset\$5 with thermoplastic with tape) and (chip or die or circuit).ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/25 20:26
-	50	(thermoset\$5 with thermoplastic with tape) same (mix\$5 or blend)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/25 21:57
-	6237	thermoset\$5 with thermoplastic with (mix\$5 or blend\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/25 21:59
-	480	(thermoset\$5 with thermoplastic with (mix\$5 or blend\$3)) and (chip or die or circuit or semiconductor).ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/25 22:00
-	98	((thermoset\$5 with thermoplastic with (mix\$5 or blend\$3)) and (chip or die or circuit or semiconductor).ab.) and tape	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/26 18:25